

STPS1045

Power Schottky rectifier

Main product characteristics

I _{F(AV)}	10 A
V _{RRM}	45 V
V _F	0.57 V

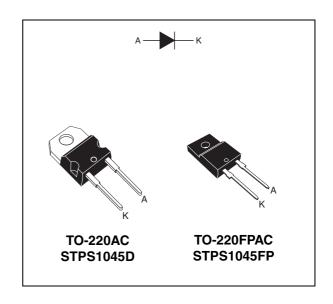
Features and Benefits

- Very small conduction losses
- Negligible switching losses
- Extremely fast switching
- Low forward voltage drop
- Insulated package: TO-220FPAC
 Insulating voltage = 2000V DC
 Capacitance = 12 pF
- Avalanche capability specified

Description

Single chip Schottky rectifier suited for Switch Mode Power Supply and high frequency DC to DC converters.

This device is intended for use in low voltage, high frequency inverters, free wheeling and polarity protection applications.



Characteristics STPS1045

Characteristics 1

Table 1. **Absolute Ratings (limiting values)**

Symbol	Parameter			Value	Unit
V _{RRM}	Repetitive peak revers	se voltage		45	V
I _{F(RMS)}	RMS forward voltage			30	Α
	Average forward	TO-220AC	T _c = 150° C	40	А
I _{F(AV)}	current $\delta = 0.5$	TO-220FPAC	T _c = 145° C	10	
I _{FSM}	Surge non repetitive for	t _p = 10 ms sinusoidal	180	Α	
	Repetitive peak reverse current $ \begin{aligned} t_p &= 2 \; \mu s \\ F &= 1 \; kHz \end{aligned} $			1	Α
P _{ARM}	Repetitive peak avalanche power			4000	W
T _{stg}	Storage temperature range			-65 to + 175	°C
T _j	Maximum junction temperature			175	°C
dV/dt	Critical rate of rise of reverse voltage			10000	V/µs

Table 2. Thermal resistances

Symbol	Parameter		Value	Unit
В	Junction to case	TO-220AC	2.2	°C/W
R _{th(j-c)}		TO-220FPAC	4.5	C/VV

Table 3. Static electrical characteristics

Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
I _B ⁽¹⁾	Povorco logicado gurront	T _j = 25° C	$V_R = V_{RRM}$			100	μΑ
'R`	I _R ⁽¹⁾ Reverse leakage current	T _j = 125° C				15	mA
		T _j = 25° C	I _F = 20 A			0.84	
V _F ⁽²⁾	V _F ⁽²⁾ Forward voltage drop	T _j = 125° C	I _F = 20 A			0.72	V
		T _j = 125° C	I _F = 10 A			0.60	

^{1.} Pulse test: $tp = 5 \text{ ms}, \delta < 2\%$

To evaluate the conduction losses use the following equation: P = 0.42 x $I_{F(AV)}$ + 0.015 $I_{F}^{2}_{(RMS)}$

$$P = 0.42 \times I_{F(AV)} + 0.015 I_{F^2(RMS)}$$

^{2.} Pulse test: tp = 380 μ s, δ < 2%

STPS1045 Characteristics

Figure 1. Average forward power dissipation Figure 2. Average forward current versus versus average forward current ambient temperature ($\delta = 0.5$)

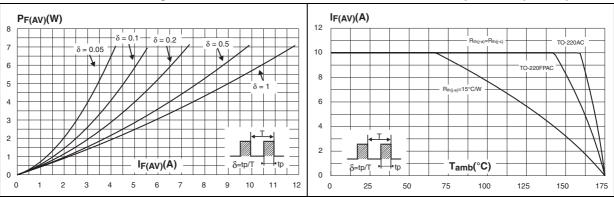


Figure 3. Normalized avalanche power derating versus pulse duration

Figure 4. Normalized avalanche power derating versus junction temperature

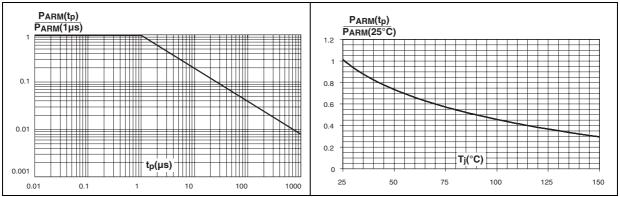
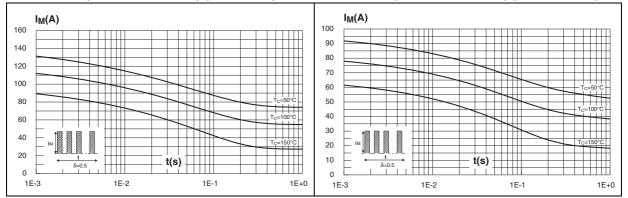


Figure 5. Non repetitive surge peak forward current versus overload duration (maximum values) (TO-220AC)

Figure 6. Non repetitive surge peak forward current versus overload duration (maximum values) (TO-220FPAC)



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Figure 7. Relative variation of thermal transient impedance junction to case versus pulse duration (TO-220AC)

Figure 8. Relative variation of thermal transient impedance junction to case versus pulse duration (TO-220FPAC)

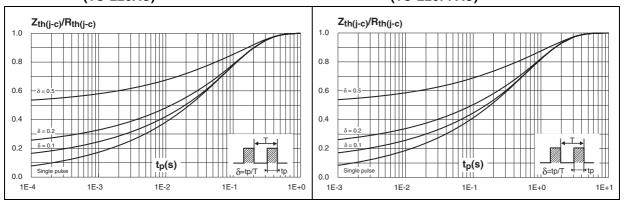


Figure 9. Reverse leakage current versus reverse voltage applied (typical values)

Figure 10. Reverse leakage current versus reverse voltage applied (typical values)

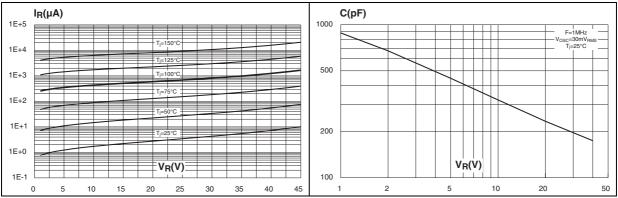
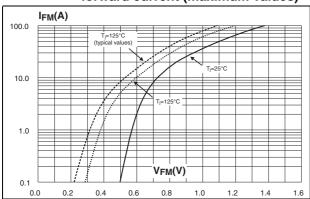


Figure 11. Forward voltage drop versus forward current (maximum values)



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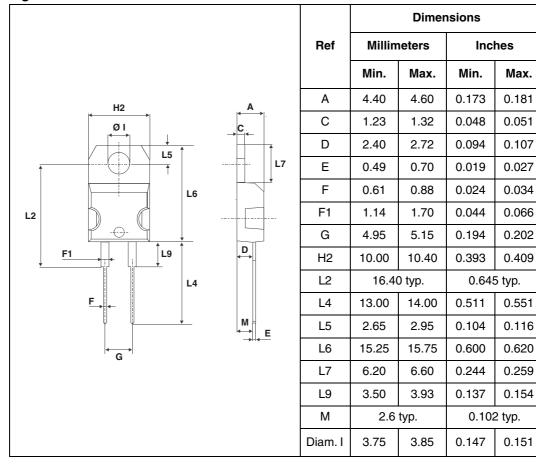
STPS1045 Package Information

2 Package Information

Epoxy meets UL94, V0

Cooling method: by conduction (C)
 Recommended torque value: 0.55 Nm
 Maximum torque value: 0.70 Nm

Figure 12. TO-220AC dimensions



Package Information STPS1045

Figure 13. TO-220FPAC dimensions

	Dimensions				
Ref	Millimeters		Inches		
	Min.	Max.	Min.	Max.	
Α	4.4	4.6	0.173	0.181	
В	2.5	2.7	0.098	0.106	
D	2.5	2.75	0.098	0.108	
Е	0.45	0.70	0.018	0.027	
F	0.75	1	0.030	0.039	
F1	1.15	1.70	0.045	0.067	
G	4.95	5.20	0.195	0.205	
G1	2.4	2.7	0.094	0.106	
Н	10	10.4	0.393	0.409	
L2	16	Тур.	0.63	Тур.	
L3	28.6	30.6	1.126	1.205	
L4	9.8	10.6	0.386	0.417	
L5	2.9	3.6	0.114	0.142	
L6	15.9	16.4	0.626	0.646	
L7	9.00	9.30	0.354	0.366	
Dia.	3.00	3.20	0.118	0.126	

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

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3 Ordering Information

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
STPS1045D	STPS1045D	TO-220AC	1.86 g	50	Tube
STPS1045FP	STPS1045FP	TO-220FPAC	1.9 g	50	Tube

4 Revision history

Date	Revision	Description of Changes
Jul-2003	5D	Last release.
22-Mar-2007	6	Removed ISOWATT package.

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